Attorney Docket No.: Q85436

AMENDMENT UNDER 37 C.F.R. § 1.116 U.S. Application No.: 10/519,144

REMARKS

Amendment summary

Claim 1 is amended to recite that the support film is not formed on the longitudinal edges of the insulating layer where the sprocket holes are formed. Support for this amendment may be found in, e.g., Figs. 4 and 5 and in the paragraph bridging pages 4 and 5 of the present specification.

No new matter is added by this Amendment, and Applicant respectfully requests entry of this Amendment.

Response to rejection of claims 1-12 under 35 U.S.C. § 102 based on Saito

Claims 1-12 were rejected under 35 U.S.C. § 102(b) as allegedly being anticipated by Saito (U.S. Patent No. 6,320,135). Applicant respectfully traverses on the basis that Saito does not teach or disclose a COF film carrier tape where the support layer is not formed on the longitudinal edges of the insulating layer where the sprocket holes are formed.

The present claims recite a chip on film film carrier tape including a continuous insulating film, a wiring pattern formed of a conductor layer provided on a surface of the insulating film, and a row of sprocket holes for use in conveyance of a film carrier tape provided on either lateral side of the wiring pattern on which electronic devices are to be mounted. A center section of the insulating layer other than opposite longitudinal edges where the sprocket holes are formed is provided with a support film formed on another surface of the insulating film, which surface is opposite to the surface on which the wiring pattern is provided. Further,

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the support film is not formed on the longitudinal edges of the insulating layer where the sprocket holes are formed, and the support film and the sprocket holes are not coplanar.

Saito disclose only a COF film carrier tape where the support layer is formed on a portion of the insulating layer corresponding to the sprocket holes. As noted above, the presently claimed invention recites that the support layer is <u>not</u> formed on a portion of the insulating layer corresponding to the sprocket holes.

Applicant respectfully submits that Saito does not disclose or suggest the presently claimed invention, and thus respectfully requests the reconsideration and withdrawal of this § 102 rejection.

Conclusion

In view of the above, reconsideration and allowance of this application are now believed to be in order, and such actions are hereby solicited. If any points remain in issue which the Examiner feels may be best resolved through a personal or telephone interview, the Examiner is kindly requested to contact the undersigned at the telephone number listed below.

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The USPTO is directed and authorized to charge all required fees, except for the Issue Fee and the Publication Fee, to Deposit Account No. 19-4880. Please also credit any overpayments to said Deposit Account.

Respectfully submitted,

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